

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Gabriele Barlocchi et al.
Filed : September 18, 2003
For : METHOD FOR FORMING HORIZONTAL BURIED
CHANNELS OR CAVITIES IN WAFERS OF
MONOCRYSTALLINE SEMICONDUCTOR
MATERIAL

Docket No. : 854063.552D1
Date : September 18, 2003

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT


Commissioner for Patents:

In accordance with 37 C.F.R. §§ 1.56 and 1.97 through 1.98, applicants wish to make known to the Patent and Trademark Office the 13 references set forth on the attached Form PTO-1449. This application relies, under 35 U.S.C. § 120, on the earlier filing date of prior Application No. 09/545,260, filed April 7, 2000. The references listed on the attached Form PTO-1449 were submitted to and/or cited by the Patent and Trademark Office in this prior application and, therefore, are not required to be provided in this application. If the Examiner wishes, copies will be provided upon request. As to any reference supplied, applicants do not admit that it is "prior art" under 35 U.S.C. §§ 102 or 103, and specifically reserve the right to traverse or antedate any such reference, as by a showing under 37 C.F.R. § 1.131 or other method. Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicants' duty to disclose all information they are aware of which is believed relevant to the examination of the above-identified application, applicants believe that their invention is patentable.

Please acknowledge receipt of this Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

Applicants believe this Information Disclosure Statement has been timely filed, however, the Commissioner is authorized to charge any fee due by way of this Information Disclosure Statement to our Deposit Account No. 19-1090.

Respectfully submitted,
Gabriele Barlocchi et al.
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Enclosures:

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| FORM PTO-1449 (REV.7-80) | | U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | | ATTY. DOCKET NO. 854063.552D1 | APPLICATION NO. | | |
| INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary) | | | | APPLICANTS Gabriele Barlocchi et al. | | | |
| | | | | FILING DATE September 18, 2003 | | GROUP ART UNIT | |

| U.S. PATENT DOCUMENTS | | | | | | | |
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| *EXAMINER INITIAL | | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
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| | | | | | YES | NO |
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| OTHER PRIOR ART <i>(Including Author, Title, Date, Pertinent Pages, Etc.)</i> | | |
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| | AR | |

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| EXAMINER | DATE CONSIDERED |
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* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).